

SN54HC259, SN74HC259 8-BIT ADDRESSABLE LATCHES

SCLS134B – DECEMBER 1982 – REVISED MAY 1997

- **8-Bit Parallel-Out Storage Register Performs Serial-to-Parallel Conversion With Storage**
- **Asynchronous Parallel Clear**
- **Active-High Decoder**
- **Enable Input Simplifies Expansion**
- **Expandable for n-Bit Applications**
- **Four Distinct Functional Modes**
- **Package Options Include Plastic Small-Outline (D), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs**

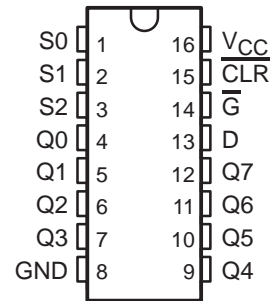
description

These 8-bit addressable latches are designed for general-purpose storage applications in digital systems. Specific uses include working registers, serial-holding registers, and active-high decoders or demultiplexers. They are multifunctional devices capable of storing single-line data in eight addressable latches, and being a 1-of-8 decoder or demultiplexer with active-high outputs.

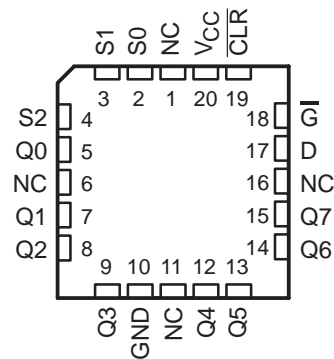
Four distinct modes of operation are selectable by controlling the clear ($\overline{\text{CLR}}$) and enable ($\overline{\text{G}}$) inputs. In the addressable-latch mode, data at the data-in terminal is written into the addressed latch. The addressed latch follows the data input with all unaddressed latches remaining in their previous states. In the memory mode, all latches remain in their previous states and are unaffected by the data or address inputs. To eliminate the possibility of entering erroneous data in the latches, $\overline{\text{G}}$ should be held high (inactive) while the address lines are changing. In the 1-of-8 decoding or demultiplexing mode, the addressed output follows the level of the D input with all other outputs low. In the clear mode, all outputs are low and unaffected by the address and data inputs.

The SN54HC259 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74HC259 is characterized for operation from -40°C to 85°C .

SN54HC259 . . . J OR W PACKAGE
SN74HC259 . . . D, N, OR PW PACKAGE
(TOP VIEW)



SN54HC259 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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Function Tables

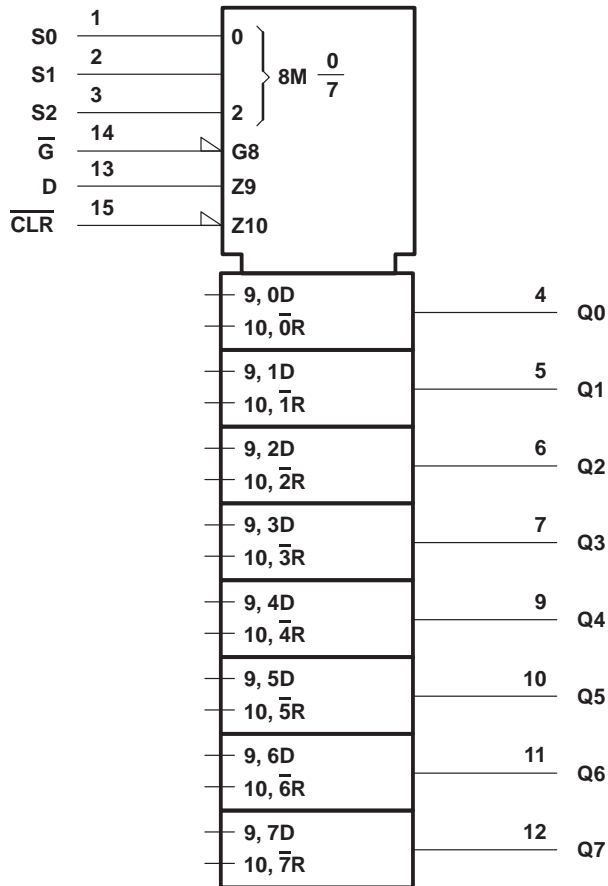
FUNCTION

INPUTS		OUTPUT OF ADDRESSED LATCH	EACH OTHER OUTPUT	FUNCTION
$\overline{\text{CLR}}$	$\overline{\text{G}}$			
H	L	D	Q_iO	Addressable latch
H	H	Q_iO	Q_iO	Memory
L	L	D	L	8-line demultiplexer
L	H	L	L	Clear

LATCH SELECTION

SELECT INPUTS			LATCH ADDRESSED
S2	S1	S0	
L	L	L	0
L	L	H	1
L	H	L	2
L	H	H	3
H	L	L	4
H	L	H	5
H	H	L	6
H	H	H	7

logic symbol†

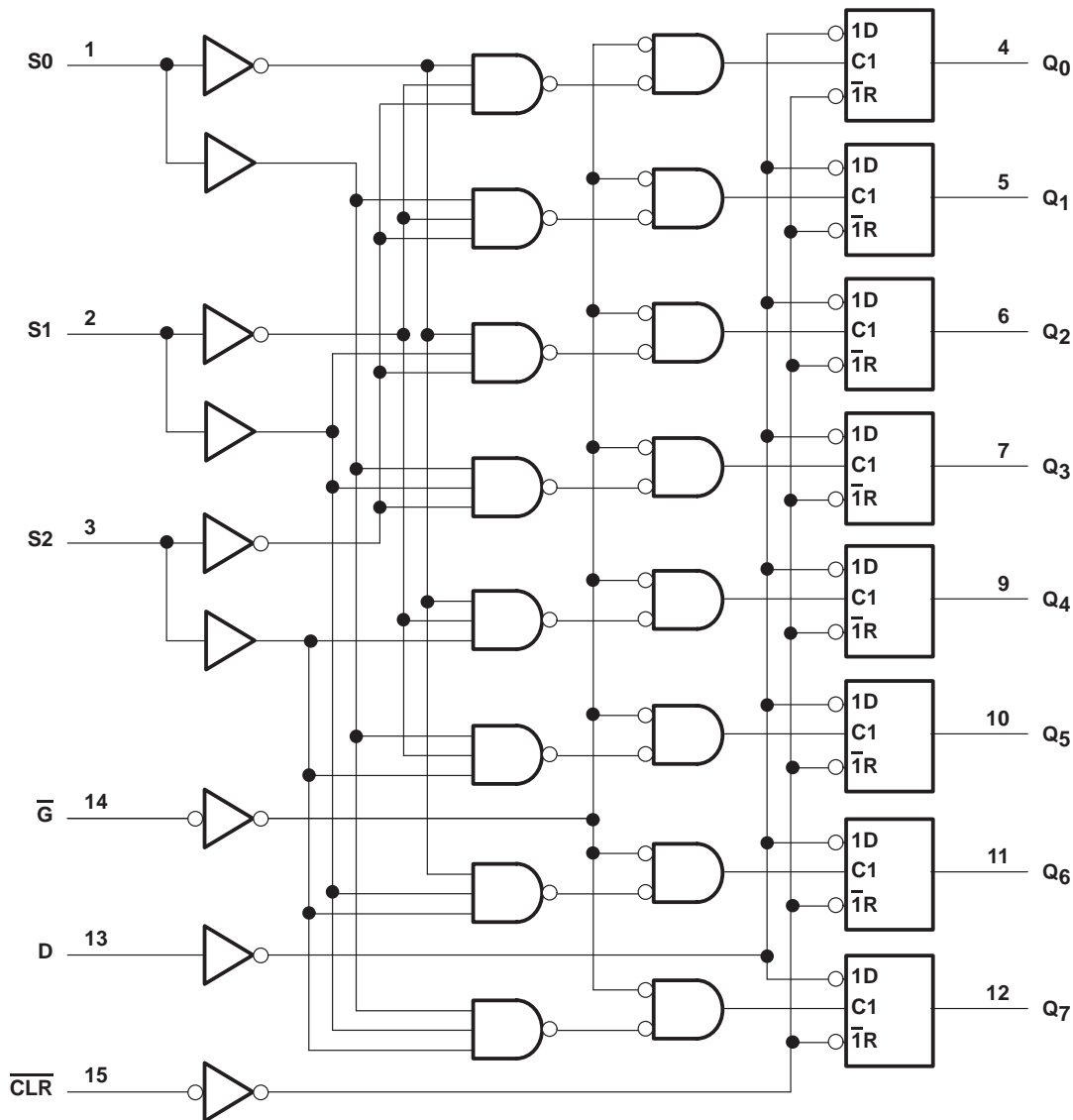


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, N, PW, and W packages.

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logic diagram (positive logic)



Pin numbers shown are for the D, J, N, PW, and W packages.

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recommended operating conditions

		SN54HC259			SN74HC259			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	2	5	6	2	5	6	V
V_{IH}	High-level input voltage	$V_{CC} = 2\text{ V}$	1.5		1.5			V
		$V_{CC} = 4.5\text{ V}$	3.15		3.15			
		$V_{CC} = 6\text{ V}$	4.2		4.2			
V_{IL}	Low-level input voltage	$V_{CC} = 2\text{ V}$	0	0.5	0	0.5		V
		$V_{CC} = 4.5\text{ V}$	0	1.35	0	1.35		
		$V_{CC} = 6\text{ V}$	0	1.8	0	1.8		
V_I	Input voltage	0	V_{CC}		0	V_{CC}		V
V_O	Output voltage	0	V_{CC}		0	V_{CC}		V
t_t	Input transition (rise and fall) time	$V_{CC} = 2\text{ V}$	0	1000	0	1000		ns
		$V_{CC} = 4.5\text{ V}$	0	500	0	500		
		$V_{CC} = 6\text{ V}$	0	400	0	400		
T_A	Operating free-air temperature	-55	125		-40	85		°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		V_{CC}	$T_A = 25^\circ\text{C}$			SN54HC259		SN74HC259		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V_{OH}	$V_I = V_{IH}$ or V_{IL}	$I_{OH} = -20\ \mu\text{A}$	2 V	1.9	1.998		1.9	1.9		V	
			4.5 V	4.4	4.499		4.4	4.4			
			6 V	5.9	5.999		5.9	5.9			
		$I_{OH} = -4\text{ mA}$	4.5 V	3.98	4.3		3.7	3.84			
		$I_{OH} = -5.2\text{ mA}$	6 V	5.48	5.8		5.2	5.34			
V_{OL}	$V_I = V_{IH}$ or V_{IL}	$I_{OL} = 20\ \mu\text{A}$	2 V		0.002	0.1		0.1	0.1		V
			4.5 V		0.001	0.1		0.1	0.1		
			6 V		0.001	0.1		0.1	0.1		
		$I_{OL} = 4\text{ mA}$	4.5 V		0.17	0.26		0.4	0.33		
		$I_{OL} = 5.2\text{ mA}$	6 V		0.15	0.26		0.4	0.33		
I_I	$V_I = V_{CC}$ or 0		6 V		± 0.1	± 100		± 1000	± 1000		nA
I_{CC}	$V_I = V_{CC}$ or 0, $I_O = 0$		6 V				8	160	80		μA
C_i			2 V to 6 V		3	10		10	10		pF



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timing requirements over recommended operating free-air temperature range (unless otherwise noted)

		V _{CC}	T _A = 25°C		SN54HC259		SN74HC259		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t _w	$\overline{\text{CLR}}$ low	2 V	80		120		100	ns	
		4.5 V	16		24		20		
		6 V	14		20		17		
	$\overline{\text{G}}$ low	2 V	80		120		100		
		4.5 V	16		24		20		
		6 V	14		20		17		
t _{su}	Setup time, data or address before $\overline{\text{G}}\uparrow$		2 V	75		115		95	ns
			4.5 V	15		23		19	
			6 V	13		20		16	
t _h	Hold time, data or address after $\overline{\text{G}}\uparrow$		2 V	5		5		5	ns
			4.5 V	5		5		5	
			6 V	5		5		5	

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC}	T _A = 25°C			SN54HC259		SN74HC259		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PHL}	$\overline{\text{CLR}}$	Any Q	2 V		60	150		225		190	ns
			4.5 V		18	30		45		38	
			6 V		14	26		38		32	
t _{pd}	Data	Any Q	2 V		56	130		195		165	ns
			4.5 V		17	26		39		33	
			6 V		13	22		33		28	
	Address	Any Q	2 V		74	200		300		250	
			4.5 V		21	40		60		50	
			6 V		17	34		51		43	
	$\overline{\text{G}}$	Any Q	2 V		66	170		255		215	
			4.5 V		20	34		51		43	
			6 V		16	29		43		37	
t _t	Any		2 V		28	75		110		95	ns
			4.5 V		8	15		22		19	
			6 V		6	13		19		16	

operating characteristics, T_A = 25°C

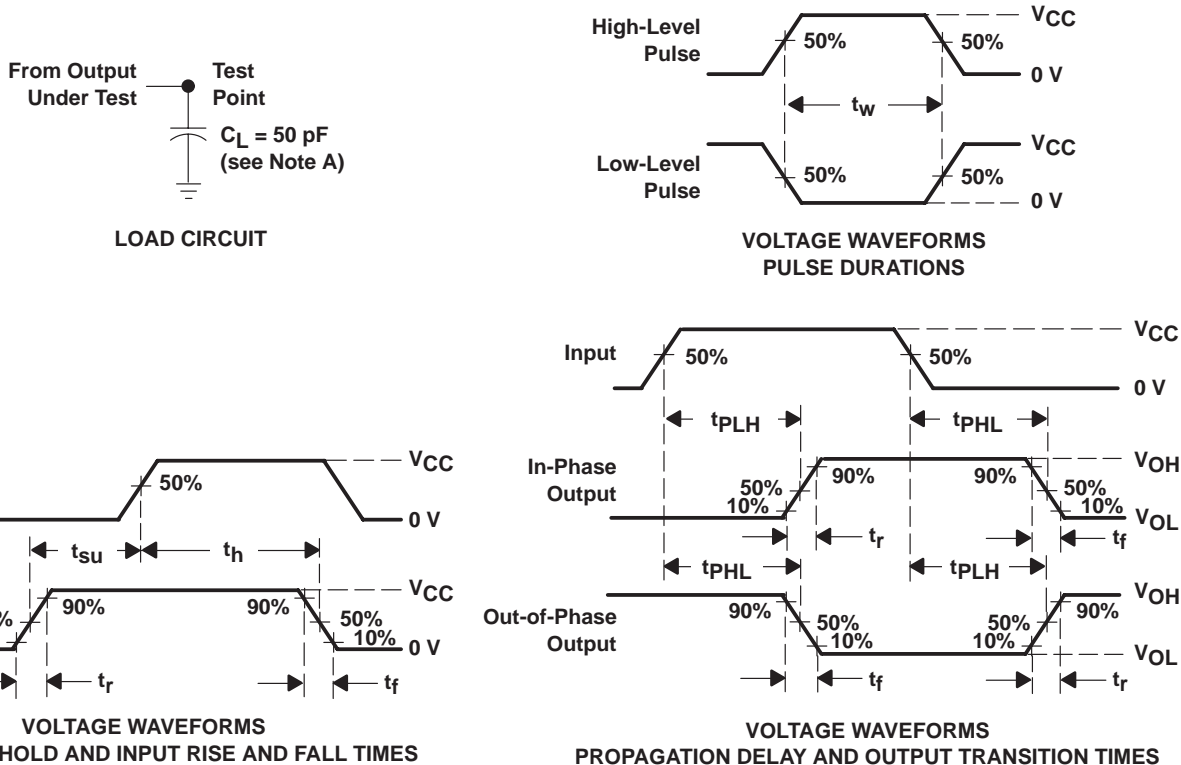
PARAMETER		TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance per latch	No load	33	pF



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PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and test-fixture capacitance.
 - B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r = 6 \text{ ns}$, $t_f = 6 \text{ ns}$.
 - C. The outputs are measured one at a time with one input transition per measurement.
 - D. t_{pLH} and t_{pHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

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